

UHF power MOS transistor

BLF543

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FEATURES

- High power gain
- Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

DESCRIPTION

Silicon N-channel enhancement mode vertical D-MOS transistor designed for communications transmitter applications in the UHF frequency range.

The transistor is encapsulated in a 6-lead, SOT171 flange envelope, with a ceramic cap. All leads are isolated from the flange.

The devices are marked with a V_{GS} indication intended for matched pair applications.

PIN CONFIGURATION

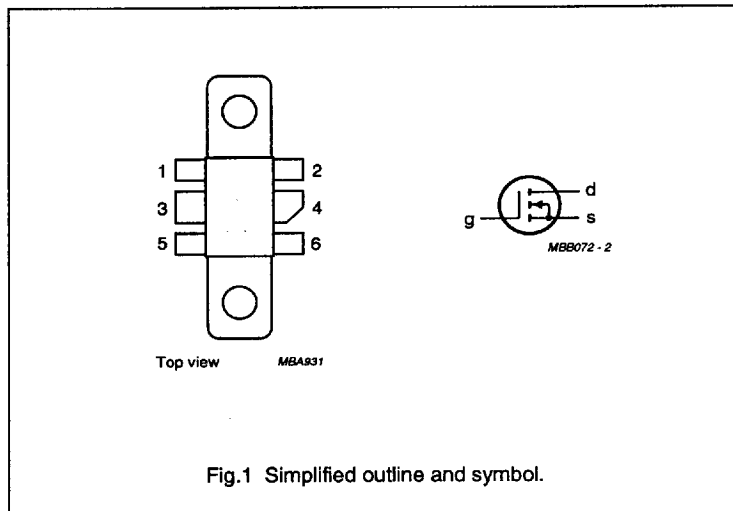


Fig.1 Simplified outline and symbol.

CAUTION

The device is supplied in an antistatic package. The gate-source input must be protected against static charge during transport and handling.

PINNING - SOT171

PIN	DESCRIPTION
1	source
2	source
3	gate
4	drain
5	source
6	source

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at $T_h = 25^\circ\text{C}$ in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V_{DS} (V)	P_L (W)	G_p (dB)	η_D (%)
CW, class-B	500	28	10	> 12	> 50
CW, class-B	960	28	10	typ. 8	typ. 50

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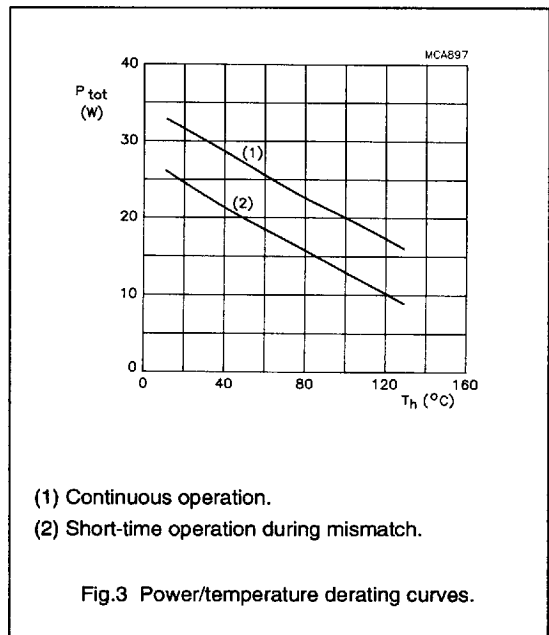
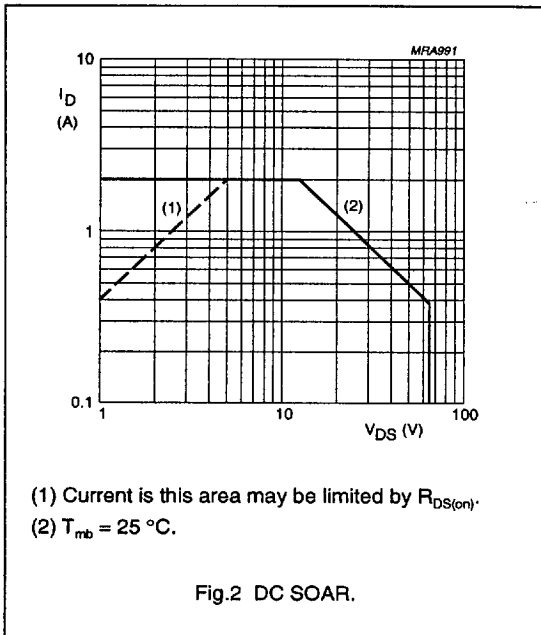
LIMITING VALUES

In accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DS}	drain-source voltage		-	65	V
$\pm V_{GS}$	gate-source voltage		-	20	V
I_D	DC drain current		-	2	A
P_{tot}	total power dissipation	up to $T_{mb} = 25^\circ\text{C}$	-	25	W
T_{stg}	storage temperature		-65	150	$^\circ\text{C}$
T_j	junction temperature		-	200	$^\circ\text{C}$

THERMAL RESISTANCE

SYMBOL	PARAMETER	THERMAL RESISTANCE
$R_{th\ j-mb}$	thermal resistance from junction to mounting base	7 K/W
$R_{th\ mb-h}$	thermal resistance from mounting base to heatsink	0.4 K/W



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CHARACTERISTICS

 $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0; I_D = 5\text{ mA}$	65	—	—	V
I_{DSS}	drain-source leakage current	$V_{GS} = 0; V_{DS} = 28\text{ V}$	—	—	0.5	mA
I_{GSS}	gate-source leakage current	$\pm V_{GS} = 20\text{ V}; V_{DS} = 0$	—	—	1	μA
$V_{GS(th)}$	gate-source threshold voltage	$I_D = 20\text{ mA}; V_{DS} = 10\text{ V}$	1	—	4	V
$\Delta V_{GS(th)}$	gate-source voltage difference of matched pairs	$I_D = 20\text{ mA}; V_{DS} = 10\text{ V}$	—	—	100	mV
g_{fs}	forward transconductance	$I_D = 0.6\text{ A}; V_{DS} = 10\text{ V}$	300	450	—	mS
$R_{DS(on)}$	drain-source on-state resistance	$I_D = 0.6\text{ A}; V_{GS} = 10\text{ V}$	—	1.7	2.5	Ω
I_{DSX}	on-state drain current	$V_{GS} = 15\text{ V}; V_{DS} = 10\text{ V}$	—	2.4	—	A
C_{is}	input capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	—	16	—	pF
C_{os}	output capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	—	12	—	pF
C_{rs}	feedback capacitance	$V_{GS} = 0; V_{DS} = 28\text{ V}; f = 1\text{ MHz}$	—	3.2	—	pF

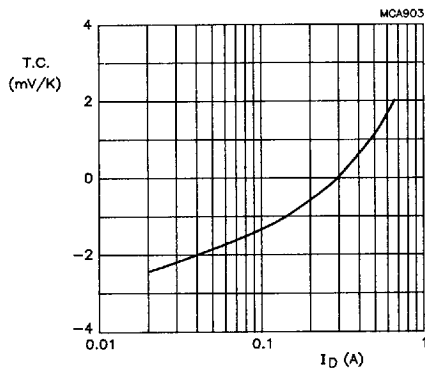
 $V_{DS} = 10\text{ V}$.

Fig.4 Temperature coefficient of gate-source voltage as a function of drain current, typical values.

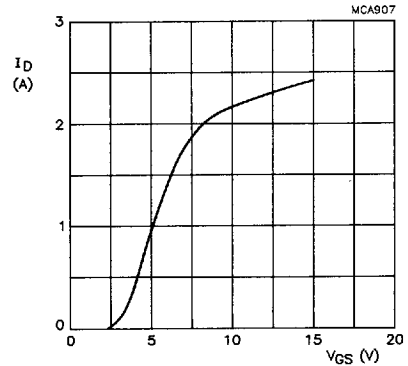
 $V_{DS} = 10\text{ V}; T_J = 25\text{ }^\circ\text{C}$.

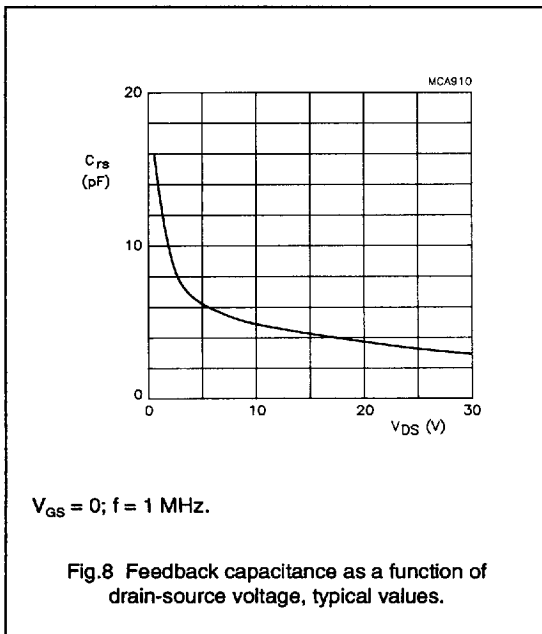
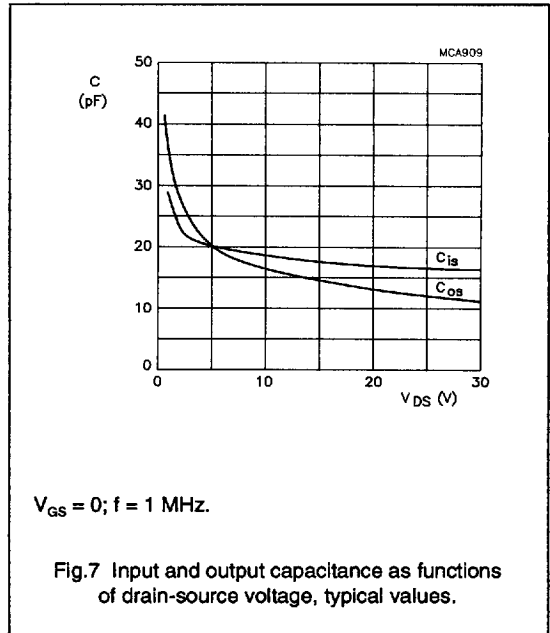
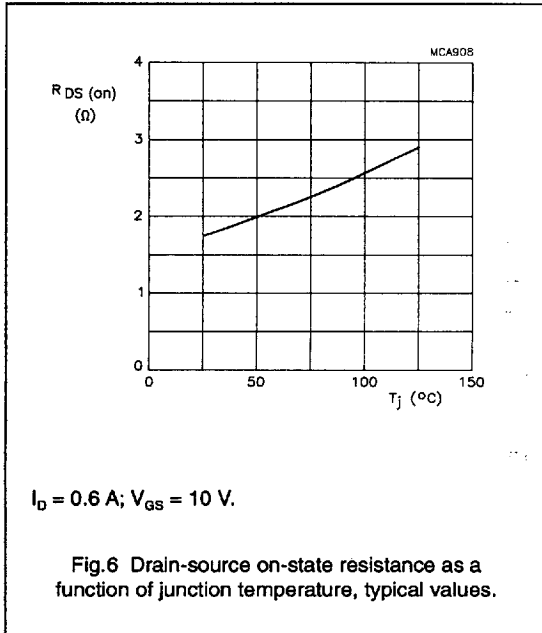
Fig.5 Drain current as a function of gate-source voltage, typical values.

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APPLICATION INFORMATION FOR CLASS-B OPERATION

$T_h = 25\text{ }^\circ\text{C}$; $R_{th, mb-h} = 0.4\text{ K/W}$, unless otherwise specified.

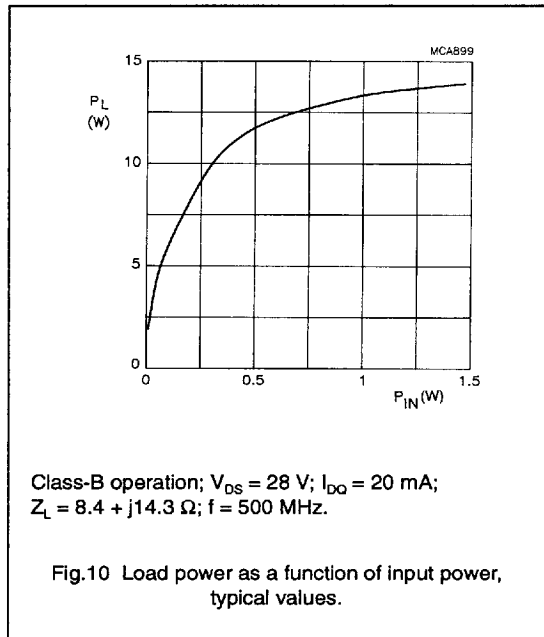
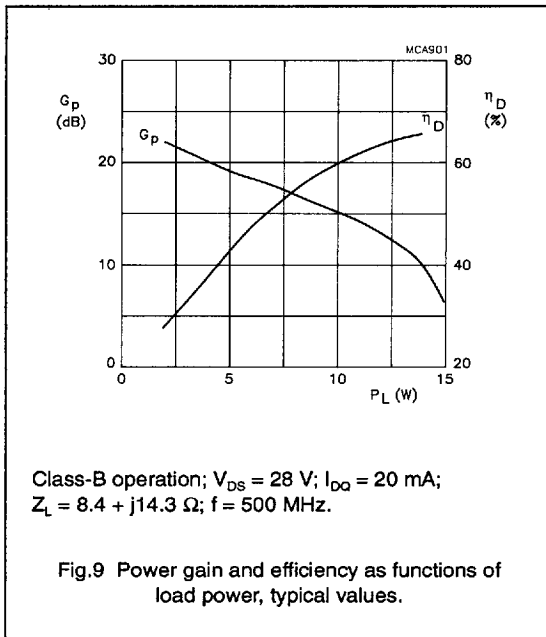
RF performance in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DO} (mA)	P _L (W)	G _p (dB)	η _D (%)
CW class-B	500	28	20	10	> 12 typ. 15	> 50 typ. 60
CW class-B	960	28	20	10	typ. 8	typ. 50
CW class-B	960	24	20	7.5	typ. 8	typ. 50

Ruggedness in class-B operation

The BLF543 is capable of withstanding a full load mismatch corresponding to VSWR = 50 through all phases under the following conditions:

V_{DS} = 28 V; f = 500 MHz at rated output power.



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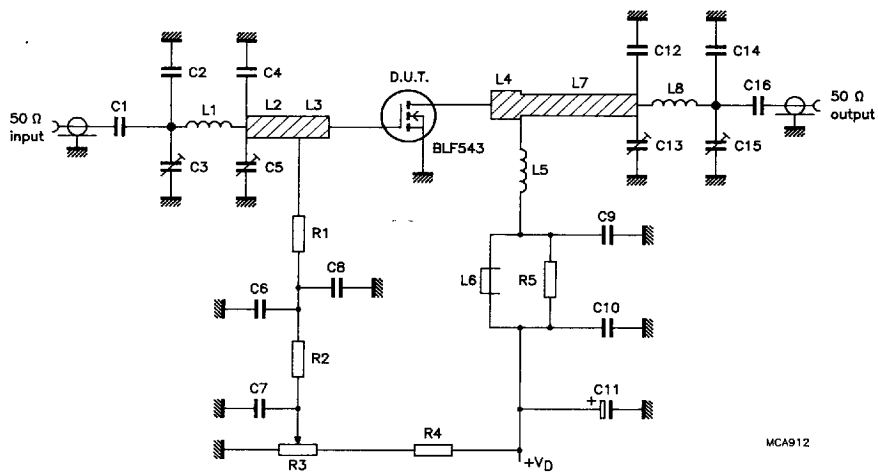


Fig.11 Test circuit for class-B operation at 500 MHz.

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List of components (class-B test circuit at 500 MHz)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C6, C9, C16	multilayer ceramic chip capacitor (note 1)	390 pF		
C2, C14	multilayer ceramic chip capacitor (note 1)	7.5 pF		
C3, C5, C13, C15	film dielectric trimmer	9 pF		2222 809 09002
C4	multilayer ceramic chip capacitor (note 1)	20 pF		
C7	multilayer ceramic chip capacitor	2 x 100 nF in parallel, 50 V		2222 852 47104
C8, C10	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C11	aluminium electrolytic capacitor	10 μ F, 63 V		2222 030 28109
C12	multilayer ceramic chip capacitor (note 1)	22 pF		
L1	1 turn enamelled 0.8 mm copper wire	11 nH	int. dia. 4.7 mm leads 2 x 5 mm	
L2	stripline (note 2)	42.5 Ω	14.5 x 3 mm	
L3, L4	stripline (note 2)	42.5 Ω	6 x 3 mm	
L5	7 turns enamelled 1 mm copper wire	124 nH	length 7.8 mm int. dia. 4 mm leads 2 x 5 mm	
L6	grade 3B Ferroxcube RF choke			4312 020 36640
L7	stripline (note 2)	55.7 Ω	31 x 2 mm	
L8	1 turn enamelled 1 mm copper wire	8 nH	int. dia. 3.2 mm leads 2 x 5 mm	
R1, R2	0.4 W metal film resistor	1 k Ω		2322 151 71002
R3	10 turns cermet potentiometer	5 k Ω		
R4	0.4 W metal film resistor	19.6 k Ω		2322 151 71963
R5	1 W metal film resistor	10 Ω		2322 153 51009

Notes

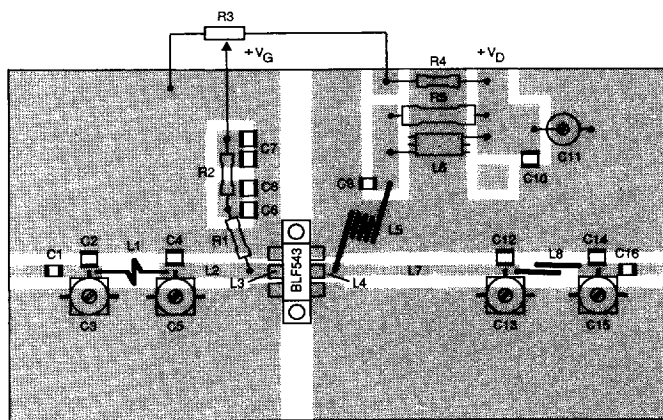
- American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

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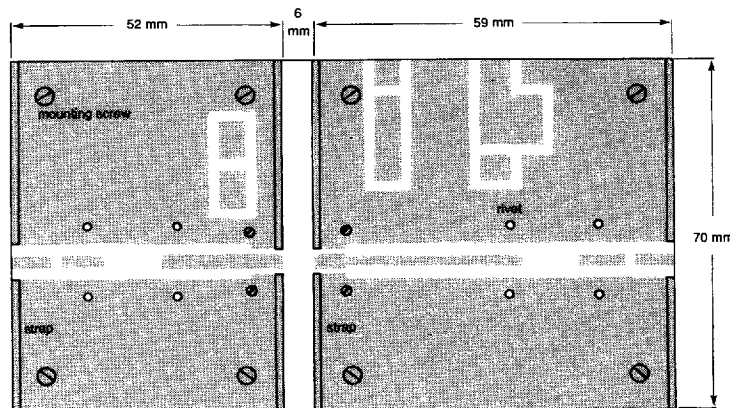
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The circuit and components are situated on one side of the printed circuit board, the other side being fully metallized, to serve as a ground plane. Earth connections are made by means of copper straps and hollow rivets for a direct contact between upper and lower sheets.

Fig.12 Component layout for 500 MHz class-B test circuit.

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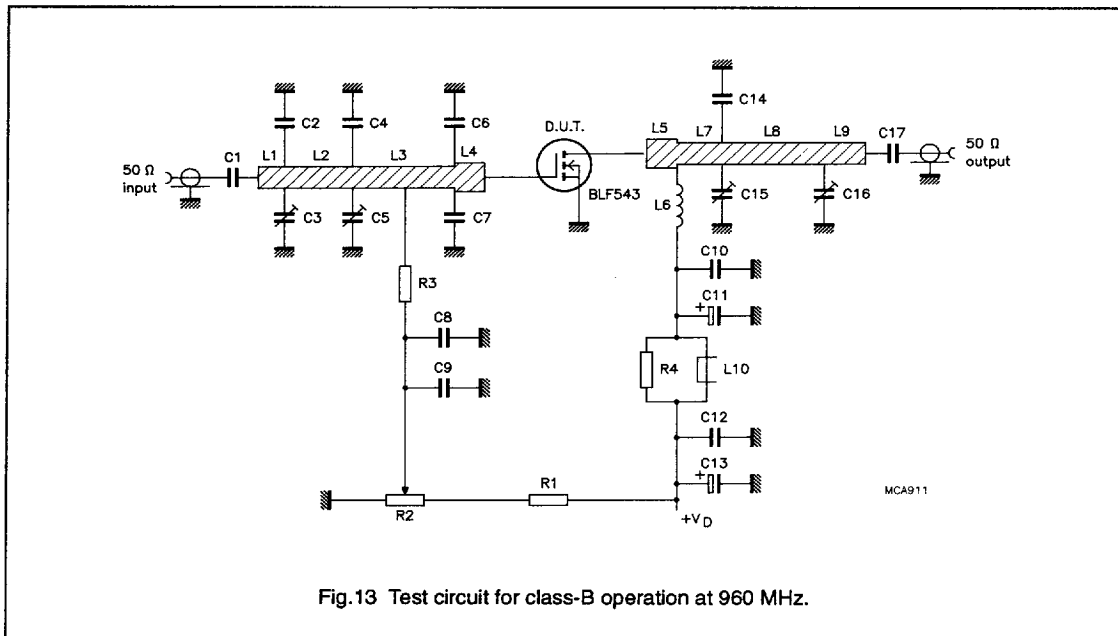


Fig.13 Test circuit for class-B operation at 960 MHz.

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List of components (class-B test circuit at 960 MHz)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C8, C10, C17	multilayer ceramic chip capacitor (note 1)	68 pF		
C2	multilayer ceramic chip capacitor (note 2)	4.7 pF		
C3, C5, C15, C16	film dielectric trimmer	1.2 to 5.5 pF		2222 808 00004
C4	multilayer ceramic chip capacitor (note 2)	2 x 5.6 pF in parallel		
C6, C7	multilayer ceramic chip capacitor (note 2)	7.5 pF		
C9, C12	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C14	multilayer ceramic chip capacitor (note 2)	2 x 4.7 pF in parallel		
C11, C13	aluminium electrolytic capacitor	10 μ F, 63 V		2222 030 28109
L1	stripline (note 3)	50 Ω	12.5 x 2.5 mm	
L2	stripline (note 3)	50 Ω	19 x 2.5 mm	
L3	stripline (note 3)	50 Ω	29.5 x 2.5 mm	
L4, L5	stripline (note 3)	42.5 Ω	3 x 3 mm	
L6	3 turns enamelled 0.8 mm copper wire	35 nH	length 4.6 mm int. dia. 4 mm leads 2 x 5 mm	
L7	stripline (note 3)	50 Ω	12.5 x 2.5 mm	
L8	stripline (note 3)	50 Ω	28.5 x 2.5 mm	
L9	stripline (note 3)	50 Ω	20.5 x 2.5 mm	
L10	grade 3B Ferroxcube RF choke			4312 020 36640
R1	0.4 W metal film resistor	205 k Ω		2322 151 72054
R2	10 turns potentiometer	50 k Ω		
R3	0.4 W metal film resistor	10 k Ω		2322 151 71003
R4	0.4 W metal film resistor	10 Ω		2322 153 51009

Notes

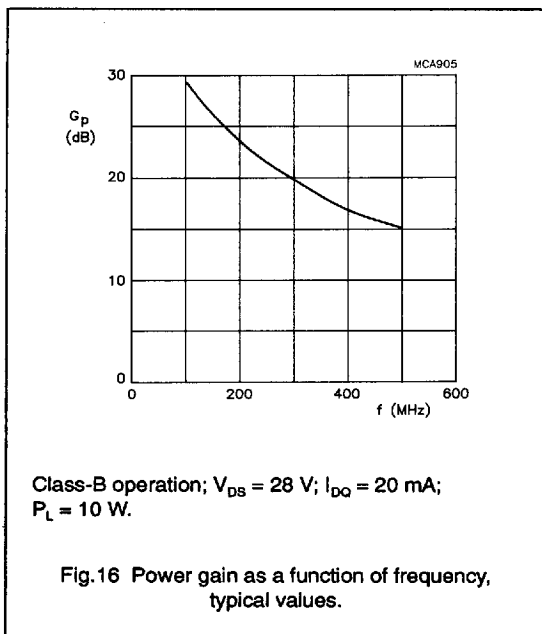
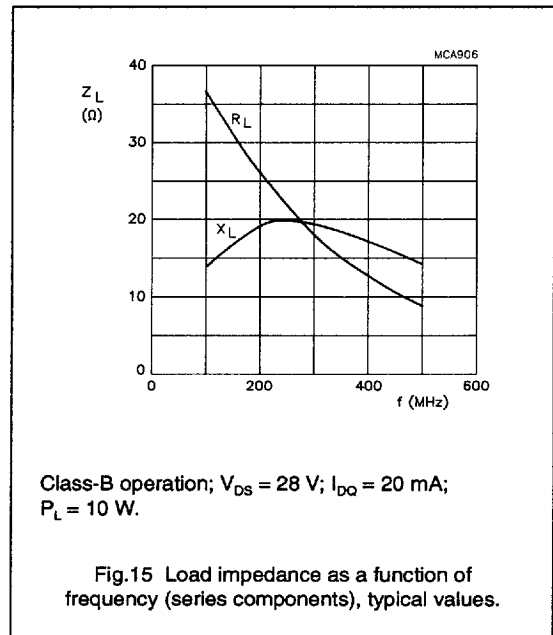
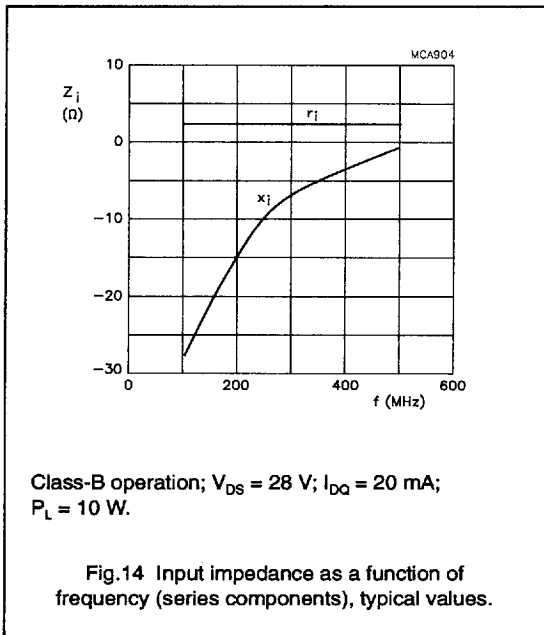
- American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.

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Optimum input and load impedances

Optimum input impedance: $2.3 + j9.5\ \Omega$.

Optimum load impedance: $4.3 + j8.6\ \Omega$.

Conditions: class-B operation; $V_{DS} = 24\text{ V}$; $I_{DQ} = 20\text{ mA}$; $f = 960\text{ MHz}$; $P_L = 7.5\text{ W}$; typical values.